

SDT-10G-20

10Gbps SFP+ Transceiver, 20km Reach

Features

1. Optical interface compliant to IEEE 802.3ae 10GBASE-LR
2. Electrical interface compliant to SFF-8431
3. Hot Pluggable
4. 1310nm DFB transmitter, PIN photo-detector
5. Operating case temperature: 0 to 70 °C
6. Low power consumption
7. Applicable for 10km/20km SMF connection
8. All-metal housing for superior EMI performance
9. Advanced firmware allow customer system encryption information to be stored in transceiver
10. Cost effective SFP+ solution, enables higher port densities and greater bandwidth

Applications

1. 10GBASE-LR at 10.3125Gbps
2. 10GBASE-LW at 9.953Gbps
3. Other optical links

Product description

This 1310 nm DFB 10Gigabit SFP+ transceiver is designed to transmit and receive optical data over single mode optical fiber for link length 10km/20km.

The SFP+ LR module electrical interface is compliant to SFI electrical specifications. The transmitter input and receiver output impedance is 100 Ohms differential. Data lines are internally AC coupled. The module provides differential termination and reduce differential to common mode conversion for quality signal termination and low EMI. SFI typically operates over 200 mm of improved FR4 material or up to about 150mm of standard FR4 with one connector.

In the transmit direction, the SFP+ transceiver module receives a 10.3125 Gb/s electrical signal (signaling rate) from the host board Asic/SerDes and converts the data to an optical signal via the Laser Driver that controls the Laser diode in the Transmitter Optical Sub-Assembly (TOSA). An open collector compatible Transmit Disable (Tx_Dis) is provided. A logic "1," or no connection on this pin will disable the laser from transmitting. A logic "0" on this pin provides normal operation. The transmitter has an internal automatic power control loop (APC) to ensure constant optical power output across

supply voltage and temperature variations. An open collector compatible Transmit Fault (TFault) is provided. TX_Fault is a module output contact that when high, indicates that the module transmitter has detected a fault condition related to laser operation or safety. The TX_Fault output contact is an open drain/collector and shall be pulled up to the Vcc_Host in the host with a resistor in the range 4.7-10 kΩ. TX_Disable is a module input contact. When TX_Disable is asserted high or left open, the SFP+ module transmitter output shall be turned off. This contact shall be pulled up to VccT with a 4.7 kΩ to 10 kΩ resistor

The receiver converts 10Gbit/s serial optical data into serial PECL/CML electrical data. An open collector compatible Loss of Signal is provided. Rx_LOS when high indicates an optical signal level below that specified in the relevant standard. The Rx_LOS contact is an open drain/collector output and shall be pulled up to Vcc_Host in the host with a resistor in the range 4.7-10 kΩ, or with an active termination. Power supply filtering is recommended for both the transmitter and receiver. The Rx_LOS signal is intended as a preliminary indication to the system in which the SFP+ is installed that the received signal strength is below the specified range. Such an indication typically points to non-installed cables, broken cables, or a disabled, failing or a powered off transmitter at the far end of the cable.

The 3rd functional capability of the SFP+ module is the 2 wire serial, I2C, interface. I2C is used for serial ID, digital diagnostics, and module control functions. The enhanced digital diagnostics monitoring interface allows real time access to the device allowing monitor of received optical power, laser bias current, laser optical output power, etc.

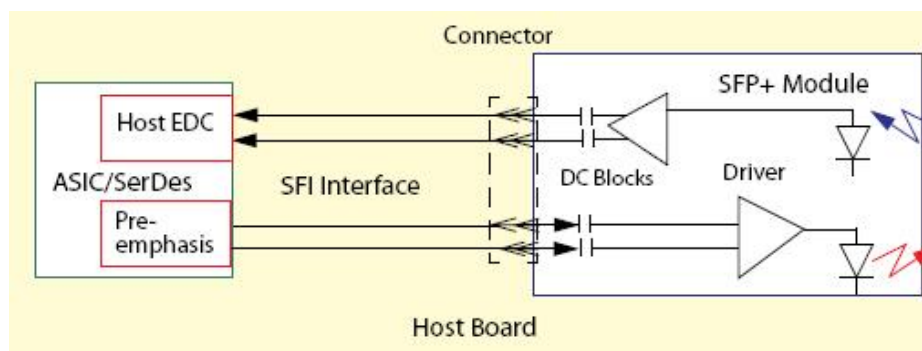


Figure 1: Interface to Host

Pin definition

The SFP+ modules are hot-pluggable. Hot pluggable refers to plugging in or unplugging a module while the host board is powered. The SFP+ host connector is a 0.8 mm pitch 20 position right angle improved connector specified by SFF-8083, or stacked connector with equivalent with equivalent electrical performance. Host PCB contact assignment is shown in Figure 2 and contact definitions are given in Table 2. SFP+ module contacts mates with the host in the order of ground, power, followed by signal as illustrated by Figure 3 and the contact sequence order listed in Table 2.

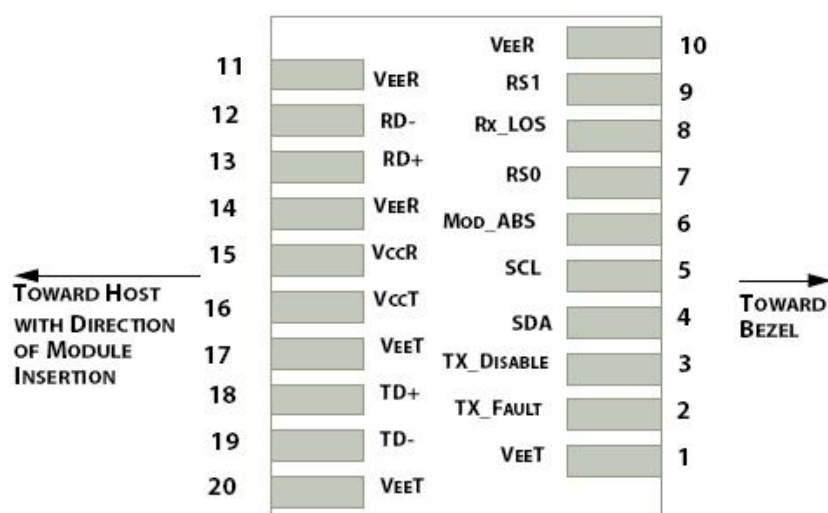


Figure 2: Interface to Host PCB

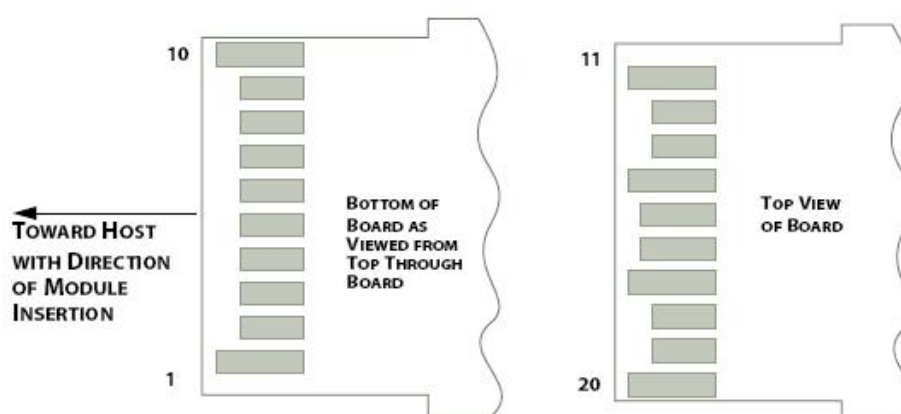


Figure 3: Module Contact Assignment

<i>Contacts</i>	<i>logic</i>	<i>Symbol</i>	<i>Power Sequence Order</i>	<i>Name/Description</i>
1		VeeT	1st	Module Transmitter Ground
2	LVTTL-O	TX_Fault	3rd	Module Transmitter Fault
3	LVTTL-I	TX_Disable	3rd	Transmitter Disable; Turns off transmitter laser output
4	LVTTL-I/O	SDA	3rd	2-wire Serial Interface Data Line (Same as MOD-DEF2 in the INF-8074i)
5	LVTTL-I/O	SCL	3rd	2-wire Serial Interface Clock (Same as MOD-DEF1 in the INF-8074i)
6		Mod_ABS	3rd	Module Absent, connected to VeeT or VeeR in the module
7	LVTTL-I	RS0	3rd	Rate Select 0, optionally controls SFP+ module receiver. When high input signaling rate > 4.25 GBd and when low input signaling rate ≤ 4.25 GBd.
8	LVTTL-O	Rx_LOS	3rd	Receiver Loss of Signal Indication (In FC designated as Rx_LOS and in Ethernet designated as Signal Detect)
9	LVTTL-I	RS1	3rd	Rate Select 1, optionally controls SFP+ transmitter. When high input signaling rate > 4.25 GBd and when low input signaling rate ≤ 4.25 GBd.
10		VeeR	1st	Module Receiver Ground
11		VeeR	1st	Module Receiver Ground
12	CML-O	RD-	3rd	Receiver Inverted Data Output
13	CML-O	RD+	3rd	Receiver Non-Inverted Data Output
14		VeeR	1st	Module Receiver Ground
15		VccR	2nd	Module Receiver 3.3 V Supply
16		VccT	2nd	Module Transmitter 3.3 V Supply
17		VeeT	1st	Module Transmitter Ground
18	CML-I	TD+	3rd	Transmitter Non-Inverted Data Input
19	CML-I	TD-	3rd	Transmitter Inverted Data Input
20		VeeT	1st	Module Transmitter Ground

Table 2: SFP+ Module PIN Definition

Absolute maximum rating

These values represent the damage threshold of the module. Stress in excess of any of the individual Absolute Maximum Ratings can cause immediate catastrophic damage to the module even if all other parameters are within Recommended Operating Conditions.

Parameters	Symbol	Min.	Max.	Unit
Power Supply Voltage	Vcc	0	+3.6	V

Storage Temperature	T _c	-40	+85	°C
Operating Case Temperature	T _c	0	+70	°C
Relative Humidity	RH	5	95	%
RX Input Average Power	P _{max}	-	0	dBm

Table 3: Absolute Maximum Rating

Recommended operating environment

Recommended Operating Environment specifies parameters for which the electrical and optical characteristics hold unless otherwise noted.

Parameter	Symbol	Min.	Typical	Max	Unit
Power Supply Voltage	V _{cc}	3.135	3.300	3.465	V
Operating Case Temperature	T _c	0	25	70	°C

Table 4: Recommended Operating Environment

Optical characteristics

The following optical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

	Unit	Values
Operating Reach	m	10K
Transmit		
Center wavelength (range)	nm	1260 -1355
Side Mode Suppression Ratio (min)	dB	30
Launched power		
– maximum	dBm	+0.5
– minimum	dBm	-8.2 Notes1
– OMA	dBm	-5.2
– OMA-TDP (min)	dBm	-6.2
Transmitter and dispersion penalty	dB	0 Notes4
Average launch power of OFF transmitter (max)	dBm	-30
Extinction ratio (min)	dB	3.5 Notes2
RIN ₁₂ OMA (max)	dB/Hz	-128
Optical Return Loss Tolerance (min)	dB	12
Receiver		
Center wavelength (range)	nm	1260-1355
Receive overload (max) in average power ¹	dBm	0.5
Receive sensitivity (min) in average power ¹	dBm	-14.4 Notes3 (10km)
	dBm	-13.4 Notes3 (20km)

Receiver sensitivity (max) in OMA (footnote 2)	dBm	-12.6	Notes3 (10km)
	dBm	-11.6	Notes3 (20km)
Receiver Reflectance (max)	dB	-12	
Stressed receiver sensitivity (max) in OMA ²	dBm	-10.3	
Vertical eye closure penalty (min) ³	dB	2.2	
Stressed eye jitter (min) ²	Ulp-p	0.7	
Receive electrical 3dB upper cutoff frequency (max)	GHz	12.3	
Receiver power (damage, Max)	dBm	1.5	
Notes: 1. The optical power is launched into SMF 2. Measured with a PRBS 2 ³¹ -1 test pattern@10.3125Gbps 3. Measured with a PRBS 2 ³¹ -1 test pattern@10.3125Gbps BER≤10 ⁻¹² 4. In G.652 and G.655(NDSF)			

Table 5: Optical Characteristics

Electrical characteristics

The following electrical characteristics are defined over the Recommended Operating Environment unless otherwise specified.

Parameter	Symbol	Min.	Typical	Max	Unit	Notes
Data Rate		-	10.3125	-	Gbps	
Power Consumption		-	1200	1500	mW	
Transmitter						
Single Ended Output Voltage Tolerance		-0.3	-	4.0	V	
C common mode voltage tolerance		15	-	-	mV	
Tx Input Diff Voltage	VI	400		1600	mV	
Tx Fault	VoL	-0.3		0.4	V	At 0.7mA
Data Dependent Input Jitter	DDJ			0.10	UI	
Data Input Total Jitter	TJ			0.28	UI	
Receiver						
Single Ended Output Voltage Tolerance		-0.3	-	4.0	V	
Rx Output Diff Voltage	Vo	300		850	mV	
Rx Output Rise and Fall Time	Tr/Tf	30			ps	20% to 80%
Total Jitter	TJ			0.70	UI	
Deterministic Jitter	DJ			0.42	UI	

Table 6: Electrical Characteristics

Control and status I/O timing characteristics

Timing characteristics of control and status I/O are included in Table 7, which is also defined in SFF-8431.

Parameter	Symbol	Min.	Max.	Unit	Conditions
TX_Disable assert time	t_off		100	µs	rising edge of TX_Disable to fall of output signal below 10% of nominal
TX_Disable negate time	t_on		2	ms	Falling edge of Tx_Disable to rise of output signal above 90% of nominal. This only applies in normal operation, not during start up or fault recovery.
Time to initialize 2-wire interface	t_2w_start_up		300	ms	From power on or hot plug after the supply meeting Table 8.
Time to initialize	t_start_up		300	ms	From power supplies meeting Table 8 or hot plug or Tx disable negated during power up, or Tx_Fault recovery, until non-cooled power level I part (or non-cooled power level II part already enabled at power level II for Tx_Fault recovery) is fully operational.
Time to initialize cooled module	t_start_up_cooled		90	s	From power supplies meeting Table 8 or hot plug, or Tx disable negated during power up or Tx_Fault recovery, until cooled power level I part (or cooled power level II part during fault recovery) is fully operational.
Time to Power Up to Level II	t_power_level2		300	ms	From falling edge of stop bit enabling power level II until non-cooled module is fully operational
Time to Power Down from Level II	t_power_down		300	ms	From falling edge of stop bit disabling power level II until module is within power level I requirements
TX_Fault assert	TX_Fault_on		1	ms	From occurrence of fault to assertion of TX_Fault
TX_Fault assert for cooled module	TX_Fault_on_cooled		50	ms	From occurrence of fault to assertion of TX_Fault
TX_Fault Reset	t_reset	10		µs	Time TX_Disable must be held high to reset TX_Fault
RS0, RS1 rate select timing for FC	t_RS0_FC, RS1_FC		500	µs	From assertion till stable output
RS0, RS1 rate select timing non FC	t_RS0, t_RS1		10	ms	From assertion till stable output
Rx_LOS assert delay	t_los_on		100	µs	From occurrence of loss of signal to assertion of Rx_LOS
Rx_LOS negate delay	t_los_off		100	µs	From occurrence of presence of signal to negation of Rx_LOS

Table 7: Timing Characteristics

Mechanical

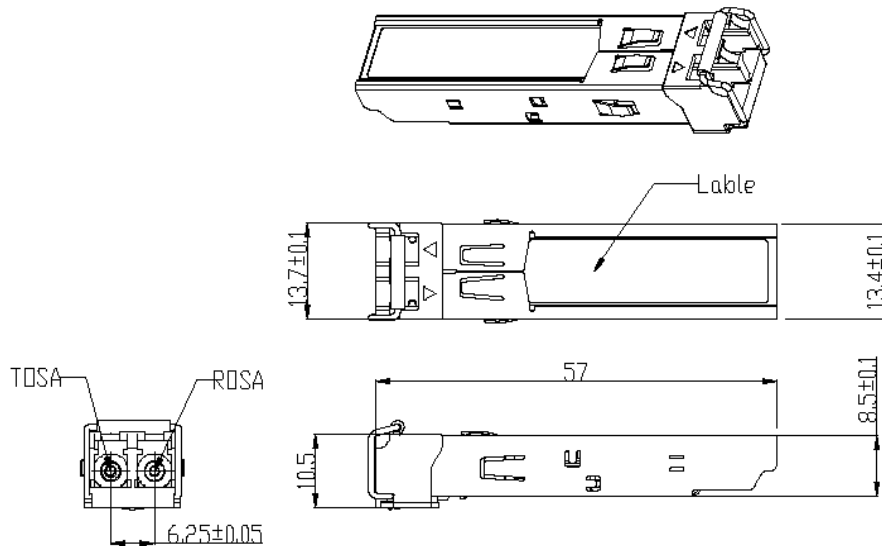


Table 8: Key Mechanical Dimensions

ESD

This transceiver is specified as ESD threshold 1kV for high speed pins and 2kV for all other electrical input pins, tested per MIL-STD-883, Method 3015.4 /JESD22-A114-A (HBM). However, normal ESD precautions are still required during the handling of this module. This transceiver is shipped in ESD protective packaging. It should be removed from the packaging and handled only in an ESD protected environment.

LASER SAFETY

This is a Class 1 Laser Product according to IEC 60825-1:1993+A1:1997+A2:2001. This product complies with 21 CFR 1040.10 and 1040.11 except for deviations pursuant to Laser Notice No. 50, dated (July 26, 2001)

Ordering information

Part Number	Product Description
SDT-10G-20	1310nm, 10Gbps, 20km, 0°C ~ +70°C